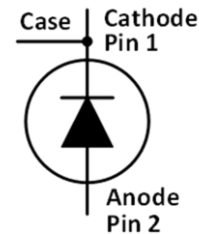
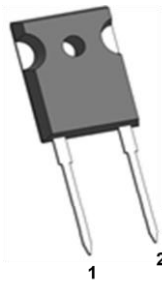


IV1D12020T2 – 1200V 20A SiC Schottky Diode

Features

- Max Junction Temperature 175°C
- High Surge Current Capacity
- Zero Reverse Recovery Current
- Zero Forward Recovery Voltage
- High-Frequency Operation
- Temperature independent switching behavior
- Positive Temperature Coefficient on V_F

Outline

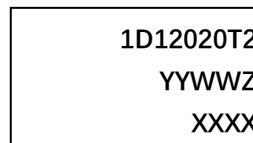


TO247-2

Applications

- Solar Power Boost
- Inverter Free Wheeling Diodes
- Vienna 3-Phase PFC
- EV Charger Piles
- Switching Mode Power Supplies

Marking Diagram



1D12020T2 = Specific Device Code
 YY = Year
 WW = Work Week
 Z = Assembly Location
 XXXX = Lot Traceability

Absolute Maximum Ratings (Tc=25°C unless otherwise specified)

Symbol	Parameter	Value	Unit
V_{RRM}	Reverse voltage (repetitive peak)	1200	V
V_{DC}	DC blocking voltage	1200	V
I_F	Forward current (continuous) @Tc=25°C	54	A
	Forward current (continuous) @Tc=135°C	28	A
	Forward current (continuous) @Tc=151°C	20	A
I_{FSM}	Surge non-repetitive forward current sine halfwave @Tc=25°C tp=10ms	140	A
I_{FRM}	Surge repetitive forward current (Freq=0.1Hz, 100cycles) sine halfwave @Tamb=25°C tp=10ms	115	A
P_{tot}	Total power dissipation @ Tc=25°C	272	W
	Total power dissipation @ Tc=150°C	45	
$\int i^2 dt$	I^2t value @Tc=25°C tp=10ms	98	A ² s
Tstg	Storage temperature range	-55 to 175	°C
Tj	Operating junction temperature range	-55 to 175	°C
M	Mounting torque (M3 screw)	0.7	Nm

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

Electrical Characteristics

Symbol	Parameter	Typ.	Max.	Unit	Test Conditions	Note
V _F	Forward Voltage	1.48	1.8	V	I _F = 20 A T _J =25°C	Fig. 1
		2.0	3.0		I _F = 20 A T _J =175°C	
I _R	Reverse Current	3	120	μA	V _R = 1200 V T _J =25°C	Fig. 2
		10	400		V _R = 1200 V T _J =175°C	
C	Total Capacitance	1114		pF	V _R = 1 V, T _J = 25°C, f = 1 MHz	Fig. 3
		100			V _R = 400 V, T _J = 25°C, f = 1 MHz	
		77			V _R = 800 V, T _J = 25°C, f = 1 MHz	
Q _C	Total Capacitive Charge	107		nC	V _R = 800 V, T _J = 25°C, Q _C = ∫ ₀ ^{V_R} C(V)dV	Fig. 4
E _C	Capacitance Stored Energy	31		μJ	V _R = 800 V, T _J = 25°C, E _C = ∫ ₀ ^{V_R} C(V) · VdV	Fig. 5

Thermal Characteristics

Symbol	Parameter	Typ.	Unit	Note
R _{th(j-c)}	Thermal Resistance from Junction to Case	0.55	°C/W	Fig.7

Typical Performance

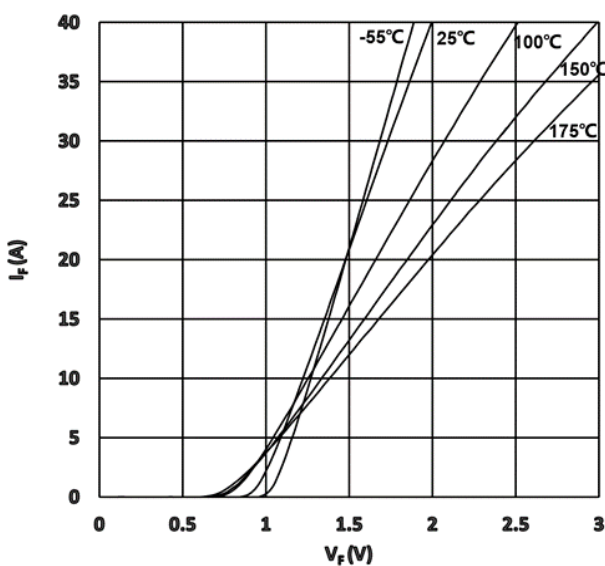


Figure 1. Typical Forward Characteristics

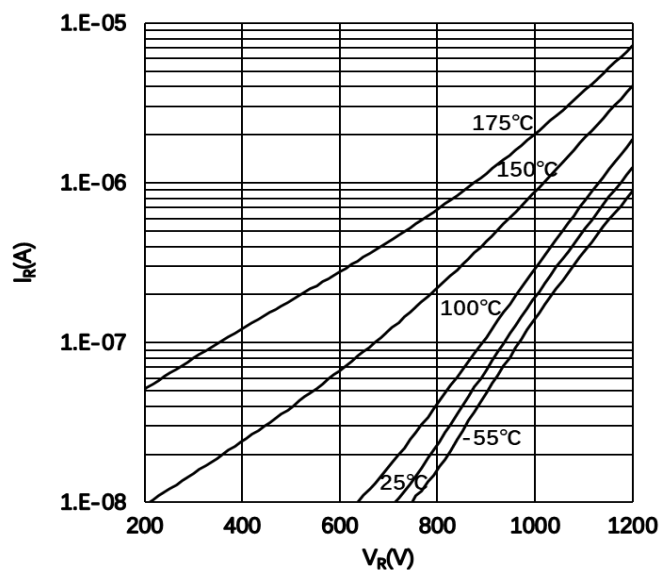


Figure 2. Typical Reverse Characteristics

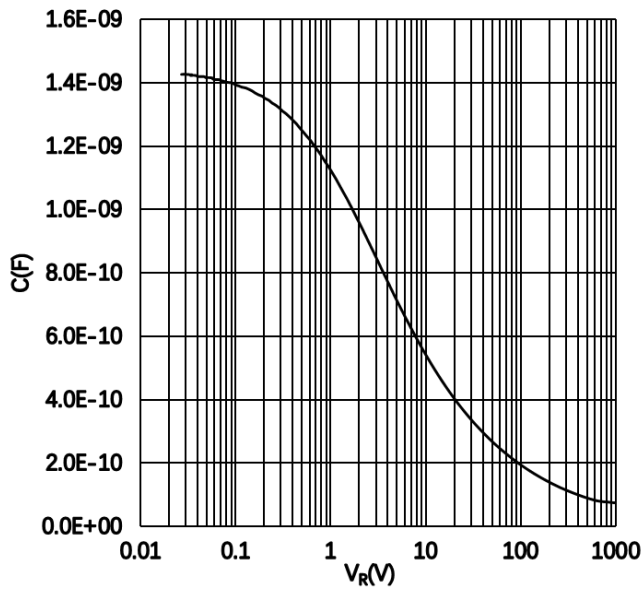


Figure 3. Capacitance vs. Reverse Voltage

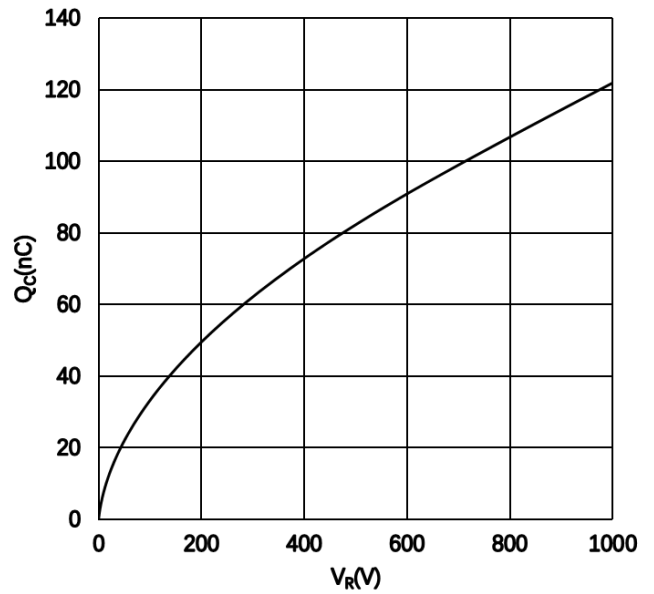


Figure 4. Recovery Charge vs. Reverse Voltage

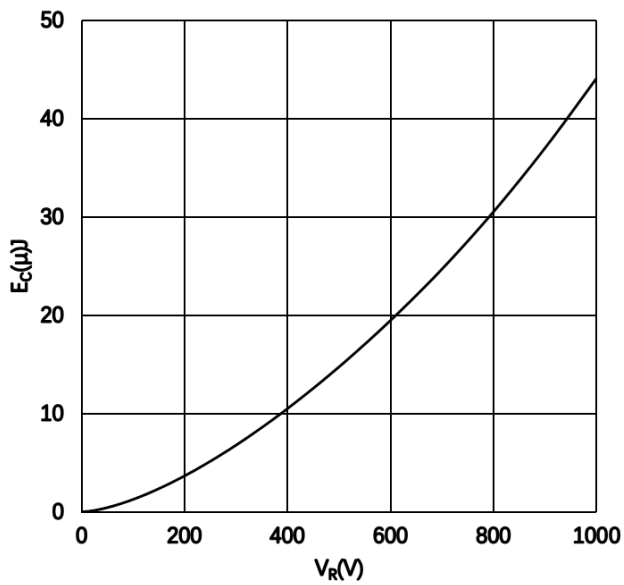


Figure 5. Capacitance Stored Energy

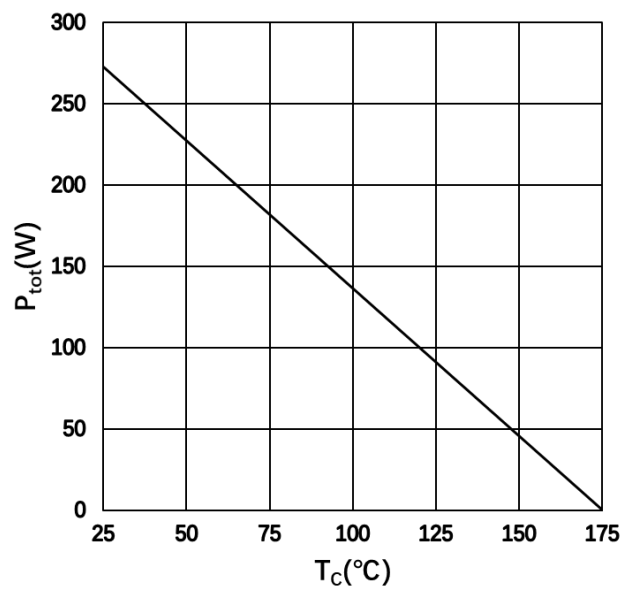


Figure 6. Power Derating

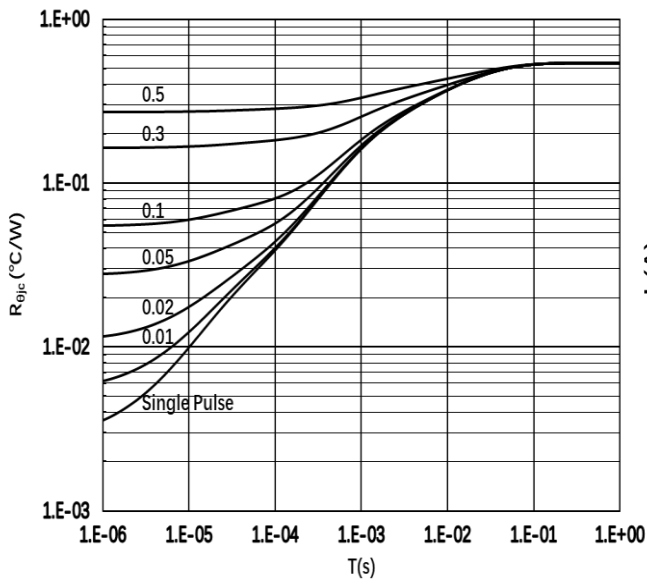


Figure 7. Transient Thermal Impedance

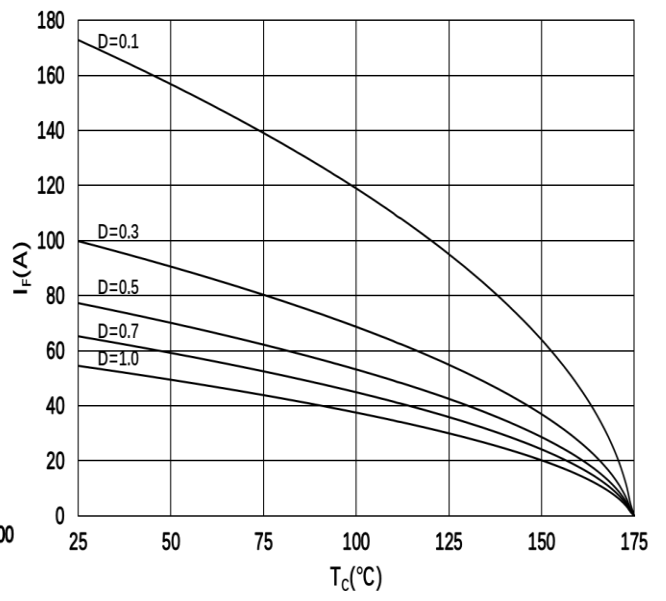
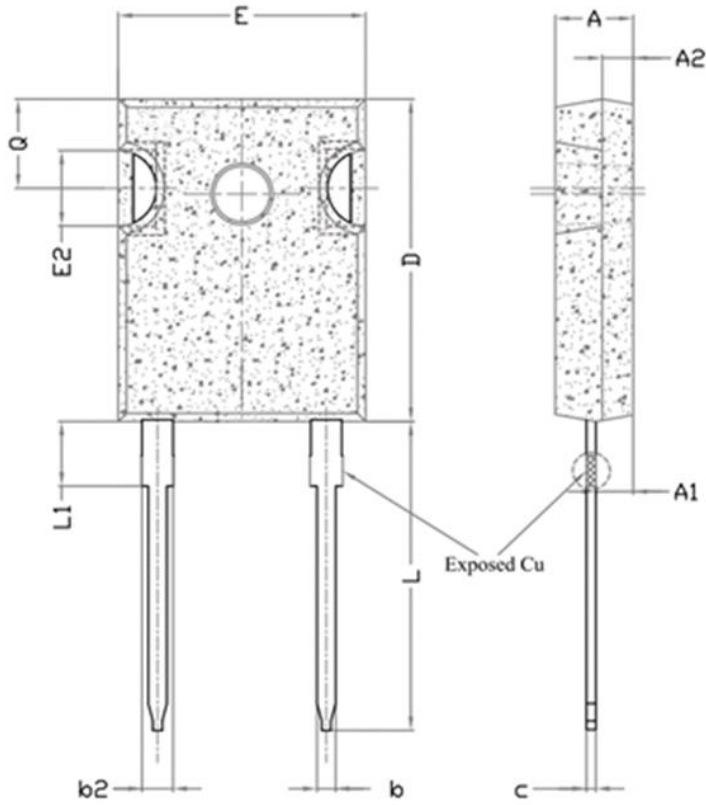
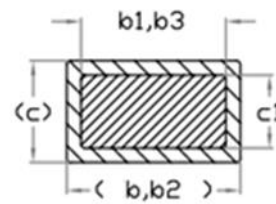
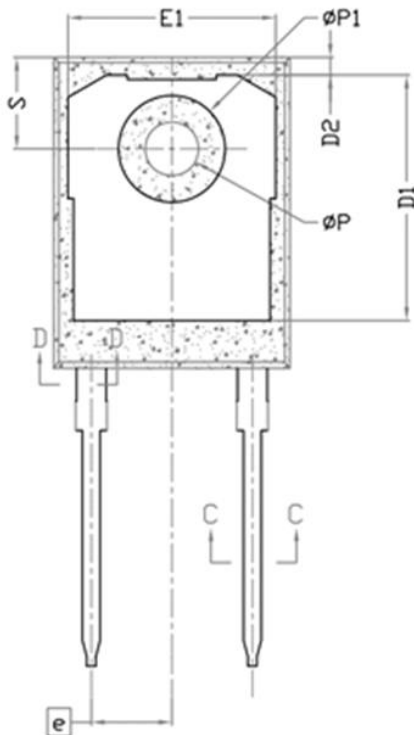


Figure 8. Forward Current as a Function of Temp.

Package Dimensions



Dimensions In Millimeters		
SYMBOL	MIN.	MAX.
A	4.83	5.21
A1	2.20	2.60
A2	1.50	2.49
b	1.00	1.40
b1	0.99	1.35
b2	1.80	2.41
b3	1.65	2.39
c	0.50	0.70
c1	0.38	0.70
D	20.30	21.10
D1	13.08	-
D2	0.51	1.35
E	15.45	16.13
E1	13.10	-
E2	3.68	5.49
e	5.44 BSC	
L	19.80	21.00
L1	-	4.50
φP	3.50	3.70
φP1	-	7.40
Q	5.39	6.20
S	6.04	6.30



Section C--C,D--D

Note:

1. Package Reference: JEDEC TO247, Variation AD
2. All Dimensions are in mm
3. Slot Required, Notch May Be Rounded or Rectangular
4. Dimension D&E Do Not Include Mold Flash
5. Subject to Change Without Notice

Notes

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